

SPECIFICATION

In the specification, please make the following corrections:

~~[0018] FIG. 9 is a cross-sectional diagram depicting another embodiment of the present invention where the coolant enters from the top causing turbulence, which enhances the cooling coefficient.~~

~~[0019]~~ [0018] FIG. 6 is a graphical representation of test results for utilizing the convective cooling theory employed by the various embodiments of the present invention.

~~[0020]~~ [0019] FIG. 7 is a cross sectional diagram depicting another embodiment of the present invention.

~~[0021]~~ [0020] FIG. 8A is a top view illustration showing a device surface that has been roughened by sandblasting.

~~[0022]~~ [0021] FIG. 8B is a top view illustration showing a device surface that has rails etched into a device surface.

~~[0023]~~ [0022] FIG. 8C is a top view illustration showing a device surface that has raised disks deposited on a device surface.

~~[0024]~~ [0023] FIG. 8D is a side view of FIG. 8B showing a device surface that has rails etched or deposited onto a device surface.

~~[0025]~~ [0024] FIG. 8E is a top view illustration showing a device surface that has raised square disks deposited on a device surface.

[0025] FIG. 9 is a cross-sectional diagram depicting another embodiment of the present invention where the coolant enters from the top causing turbulence, which enhances the cooling coefficient.